

#### Chip NTC Thermistors (Protection Device)

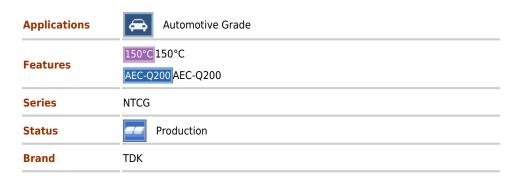
### NTCG103JF103HT1S

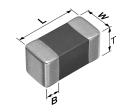












Size		
Length(L)	1.00mm ±0.05mm	
Width(W)	0.50mm ±0.05mm	
Thickness(T)	0.50mm ±0.05mm	
Terminal Width(B)	0.10mm Min.	
Recommended Land Pattern (PA)	0.50mm ±0.10mm	
Recommended Land Pattern (PB)	0.50mm ±0.10mm	
Recommended Land Pattern (PC)	0.50mm ±0.10mm	

Electrical Characteristics		
Resistance [at 25°C]	10kΩ	
Resistance Tolerance	±3%	
B value (Typ.) [25/50°C]	3380K	
B value (Typ.) [25/85°C]	3435K	
B value (Typ.) [25/100°C]	3453K	
B value Tolerance	±1%	
Max. Electric Power [at 25°C]	100mW	
Permissive Operating Current [at 25°C]	310µA	
Thermal Dissipation Constant [at 25°C]	1mW/°C   1mW/K	

Other	
Max. Operating Temperature	150°C
Soldering Method	Reflow
UL File No.	
AEC-Q200	Yes
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs
Weight	0.0013g

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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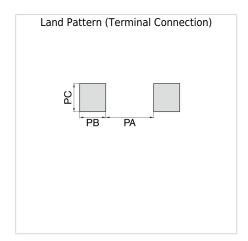








# **Associated Images**



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